AUTOMOTIVE GRADE

COMPLIANT

HALOGEN FREE

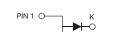


Vishay General Semiconductor

High Current Density Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier

Ultra Low $V_F = 0.36 \text{ V}$ at $I_F = 3 \text{ A}$





LINKS TO ADDITIONAL RESOURCES



| PRIMARY CHARACTERISTICS | | | | |
|--|---------------------|--|--|--|
| I _{F(AV)} | 6 A | | | |
| V _{RRM} | 60 V | | | |
| I _{FSM} | 100 A | | | |
| V_F at $I_F = 6$ A ($T_J = 125$ °C) | 0.46 V | | | |
| T _J max. | 150 °C | | | |
| Package | SlimDPAK (TO-252AE) | | | |
| Circuit configuration | Single | | | |

FEATURES

- Very low profile typical height of 1.3 mm
- Trench MOS Schottky technology
- · Ideal for automated placement
- · Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in low voltage high frequency DC/DC converters, freewheeling diodes, and polarity protection applications.

MECHANICAL DATA

Case: SlimDPAK (TO-252AE)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

| MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted) | | | | |
|--|-------------------------------|-------------|------|--|
| PARAMETER | SYMBOL | V6PW60 | UNIT | |
| Device marking code | | V6PW60 | | |
| Maximum repetitive peak reverse voltage | V _{RRM} | 60 | V | |
| Maximum average forward rectified current (Fig. 1) | I _{F(AV)} (1) | 6 | A | |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load | I _{FSM} | 100 | А | |
| Operating junction temperature range | T _J ⁽²⁾ | -40 to +150 | °C | |
| Storage temperature range | T _{STG} | -55 to +150 | °C | |

Notes

⁽¹⁾ With infinite heatsink

⁽²⁾ The heat generated must be less than the thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{6JA}$



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| ELECTRICAL CHARACTERISTICS (T _J = 25 °C unless otherwise noted) | | | | | | |
|---|-----------------------|-------------------------|-------------------------------|------|------|------|
| PARAMETER | TEST CONDITIONS | | SYMBOL | TYP. | MAX. | UNIT |
| Instantaneous forward voltage | I _F = 3 A | T _J = 25 °C | V _F ⁽¹⁾ | 0.46 | - | V |
| | I _F = 6 A | | | 0.53 | 0.58 | |
| | I _F = 3 A | T _J = 125 °C | | 0.36 | - | |
| | I _F = 6 A | | | 0.46 | 0.52 | |
| Reverse current | V _R = 60 V | T _J = 25 °C | I _R ⁽²⁾ | - | 0.4 | mA |
| | v _R = 60 v | T _J = 125 °C | | 6 | 20 | |
| Typical junction capacitance | 4.0 V, 1 MHz | | CJ | 750 | - | pF |

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

 $^{(2)}$ Pulse test: pulse width ≤ 5 ms

| THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | |
|---|---------------------------------|-----|------|--|
| PARAMETER | SYMBOL V6PW60 | | | |
| Typical thermal registance | R _{θJA} (1)(2) | 65 | °C/W | |
| Typical thermal resistance | R _{θJM} ⁽³⁾ | 3.0 | | |

Notes

 $^{(1)}$ The heat generated must be less than thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

 $^{(2)}$ Free air, mounted on recommended copper pad area; thermal resistance $R_{\theta JA}$ - junction to ambient

 $^{(3)}$ Mounted on infinite heat sink; thermal resistance $R_{\theta JM}$ - junction-to-mount

| ORDERING INFORMATION (Example) | | | | | |
|--------------------------------|-----------------|--|------|------------------------------------|--|
| PREFERRED P/N | UNIT WEIGHT (g) | EIGHT (g) PREFERRED PACKAGE CODE BASE QUANTITY | | DELIVERY MODE | |
| V6PW60-M3/I | 0.20 | I | 4500 | 13" diameter plastic tape and reel | |
| V6PW60HM3/I (1) | 0.20 | I | 4500 | 13" diameter plastic tape and reel | |

Note

(1) AEC-Q101 qualified

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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

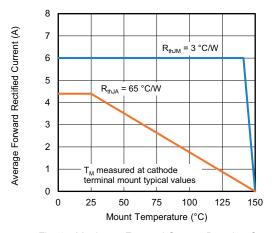


Fig. 1 - Maximum Forward Current Derating Curve

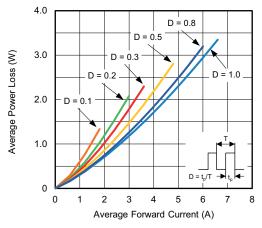


Fig. 2 - Forward Power Loss Characteristics

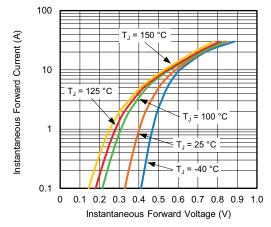


Fig. 3 - Typical Instantaneous Forward Characteristics

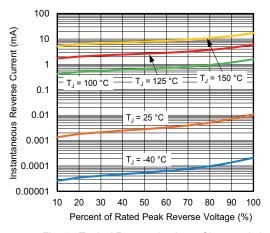


Fig. 4 - Typical Reverse Leakage Characteristics

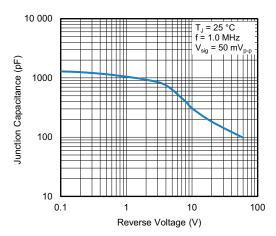


Fig. 5 - Typical Junction Capacitance

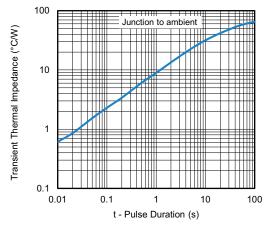


Fig. 6 - Typical Transient Thermal Impedance



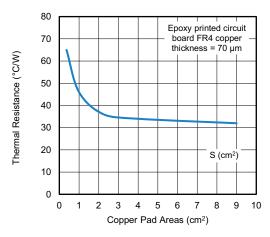
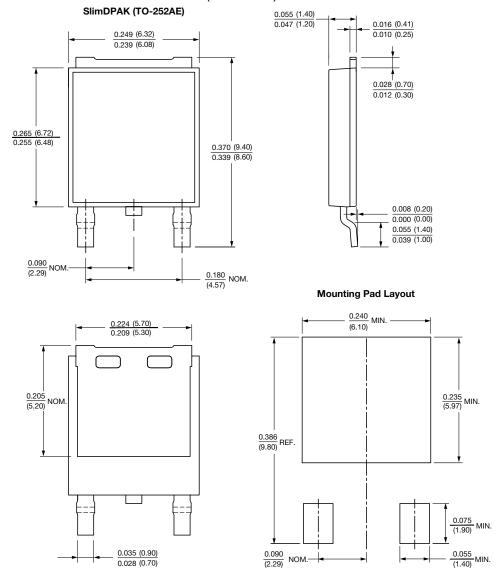


Fig. 7 - Typical Resistance Junction to Ambient vs. Copper Pad Areas

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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